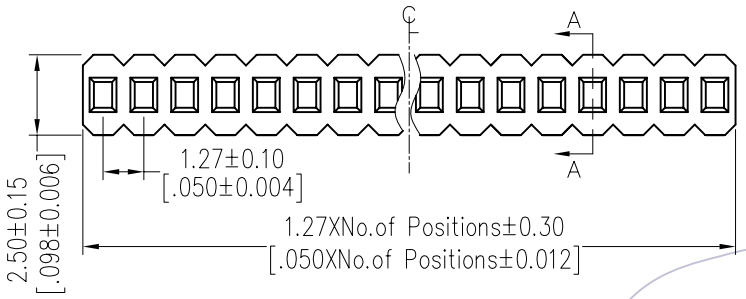
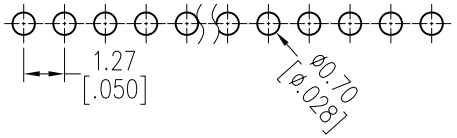
HSF

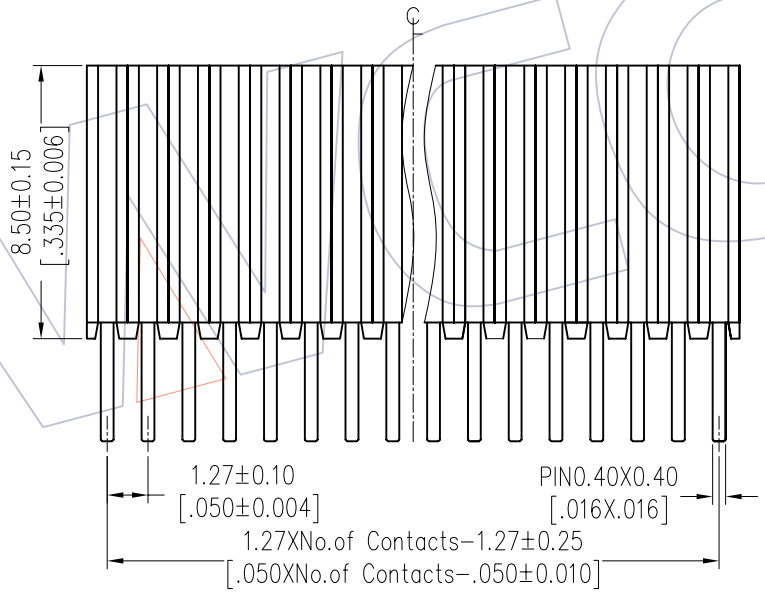
NOTES:
Current Rating: 1.0AMP
Contact Resistance: 20mΩ Max
Withstand Voltage: 500V AC/DC
Insulation Resistance: 1000MΩ Min
Operation Temperature: −40℃ to +105℃

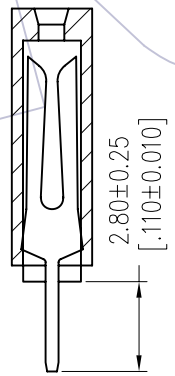
Contact Material: Phosphor Bronze
Contact plating: Au over Ni
Insulator Material: PA9T+30%GF UL94V−0



Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)







SECTION A−A

Ordering Information

2385-1 XX S XX CYN T 1

- XX: No.of Pins per Row: 02~50Pin
- XX: Contact Plating: G0=Gold Flash, G3=10μ"Gold, G4=15μ"Gold, G5=30μ"Gold
- T: Packing: T=Tube

Item	Pitch	Mating
Standard	1.27	1317/1325
Alternate		

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2012/07/12	NEW	------

OPERATION	
X.X	±0.40
X.XX	±0.25
X.XXX	±0.15
Angle	± 3°
DIM	TOL

DRAW	JYHuang	DATE	2012/07/12
CHECK		DATE	
APPROVE		DATE	

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

PART NO. 2385-1XXSXXCYNT1

TITLE: FH1.27mm SINGLE ROW 180° DIP H=8.50

Customer NO.

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